



# MPC817X1 Series

## DIP4, DC Input, Photo Transistor Coupler

### Description

The MPC817X1 series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a silicon planar phototransistor detector in a plastic DIP4 package with different lead forming options. With the robust coplanar double mold structure, MPC817X1 series provide the most stable isolation feature.

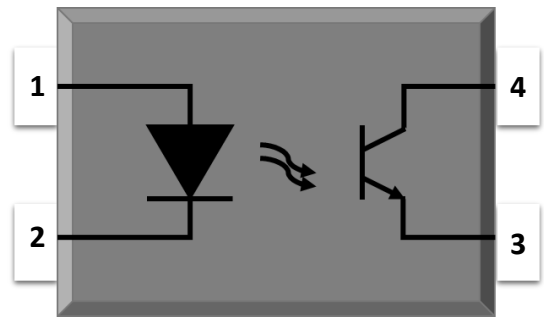
### Features

- High isolation 5000 VRMS
- CTR flexibility available see order information
- DC input with transistor output
- Operating temperature range - 55 °C to 110 °C
- RoHS & REACH Compliance
- MSL class 1
- Halogen free (Optional)
- Regulatory Approvals
  - UL - UL1577
  - VDE - EN60747-5-5(VDE0884-5)
  - CQC – GB4943.1, GB8898

### Applications

- Switch mode power supplies
- Programmable controllers
- Household appliances
- Office equipment

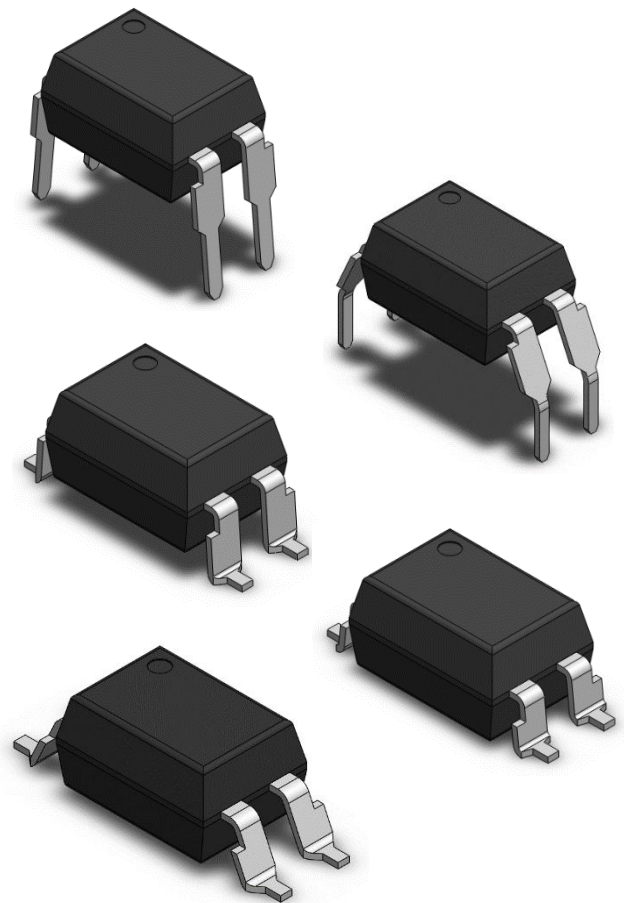
### SCHEMATIC



### PIN DEFINITION

1. Anode
2. Cathode
3. Emitter
4. Collector

### PACKAGE OUTLINE





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### ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	VALUE	UNIT	NOTE
INPUT				
Forward Current	$I_F$	60	mA	
Peak Forward Current	$I_{FP}$	1	A	1
Reverse Voltage	$V_R$	6	V	
Input Power Dissipation	$P_I$	100	mW	
OUTPUT				
Collector - Emitter Voltage	$V_{CEO}$	35	V	
Emitter - Collector Voltage	$V_{ECO}$	7	V	
Collector Current	$I_C$	50	mA	
Output Power Dissipation	$P_O$	150	mW	
COMMON				
Total Power Dissipation	$P_{tot}$	200	mW	
Isolation Voltage	$V_{iso}$	5000	Vrms	2
Operating Temperature	$T_{opr}$	-55~110	°C	
Storage Temperature	$T_{stg}$	-55~125	°C	
Soldering Temperature	$T_{sol}$	260	°C	

Note 1. 100 $\mu$ s pulse, 100Hz frequency

Note 2. AC For 1 Minute, R.H. = 40 ~ 60%



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ELECTRICAL OPTICAL CHARACTERISTICS at Ta=25°C								
PARAMETER	SYMBOL	MIN	TYP.	MAX.	UNIT	TEST CONDITION	NOTE	
INPUT								
Forward Voltage	V <sub>F</sub>	-	1.24	1.4	V	IF=10mA		
Reverse Current	I <sub>R</sub>	-	-	10	μA	VR=6V		
Input Capacitance	C <sub>in</sub>	-	10	-	pF	V=0, f=1kHz		
OUTPUT								
Collector Dark Current	I <sub>CEO</sub>	-	-	100	nA	VCE=20V, IF=0		
Collector-Emitter Breakdown Voltage	BV <sub>CEO</sub>	35	-	-	V	IC=0.1mA, IF=0		
Emitter-Collector Breakdown Voltage	BV <sub>ECO</sub>	6	-	-	V	IE=0.1mA, IF=0		
TRANSFER CHARACTERISTICS								
Current Transfer Ratio	MPC817A1	CTR	80	-	160	%	IF=5mA, VCE=5V	
	MPC817B9		130	-	260			
	MPC817C1		200	-	400			
	MPC817D1		300	-	600			
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	-	0.06	0.2	V	IF=20mA, IC=1mA		
Isolation Resistance	R <sub>ISO</sub>	10 <sup>12</sup>	10 <sup>14</sup>	-	Ω	DC500V, 40 ~ 60% R.H.		
Floating Capacitance	C <sub>IO</sub>	-	0.4	1	pF	V=0, f=1MHz		
Cut-off Frequency	f <sub>c</sub>	-	80	-	kHz	VCE=2V, IC=2mA RL=100Ω, -3dB	3	
Response Time (Rise)	t <sub>r</sub>	-	6	18	μs	VCE=2V, IC=2mA	4	
Response Time (Fall)	t <sub>f</sub>	-	8	18	μs	RL=100Ω	4	

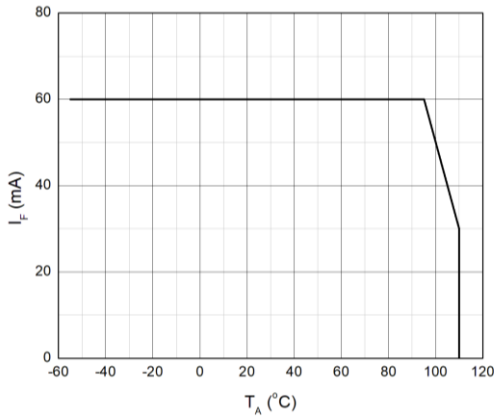
Note 3. Fig.12&13

Note 4. Fig.14

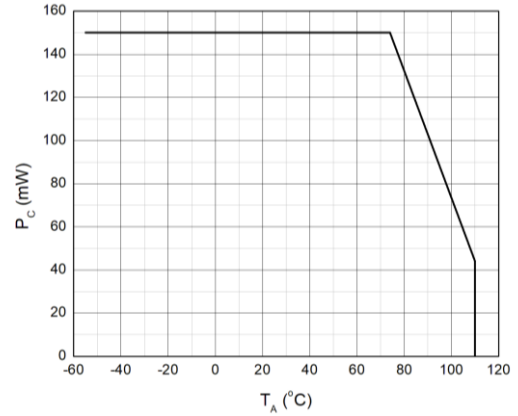


### CHARACTERISTIC CURVES

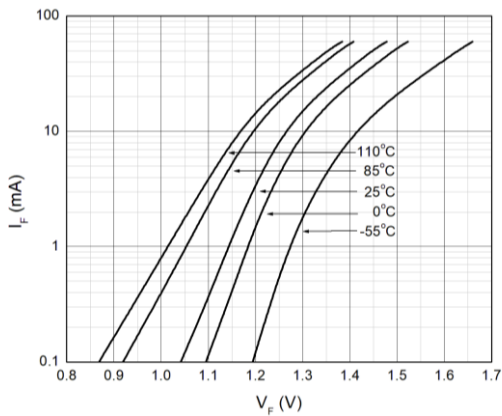
**Fig.1 Forward Current vs. Ambient Temperature**



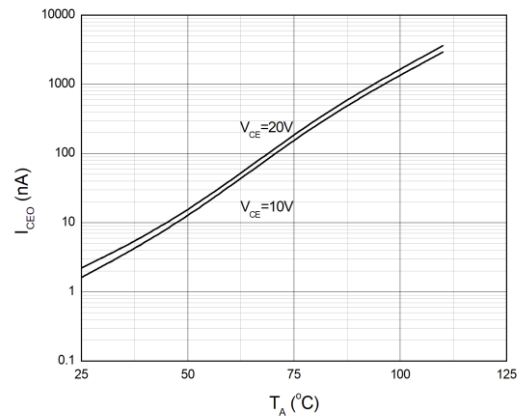
**Fig.2 Collector Power Dissipation vs. Ambient Temperature**



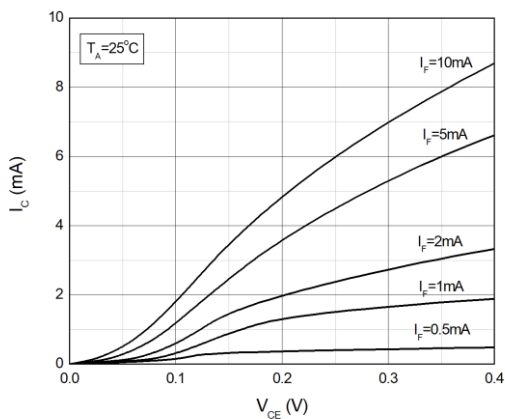
**Fig.3 Forward Current vs. Forward Voltage**



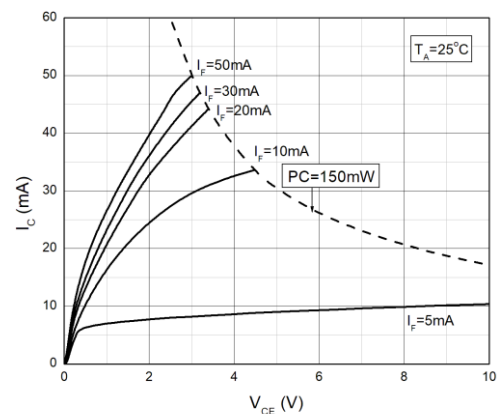
**Fig.4 Collector Dark Current vs. Ambient Temperature**



**Fig.5 Collector Current vs. Collector-emitter Voltage**



**Fig.6 Collector Current vs. Collector-emitter Voltage**



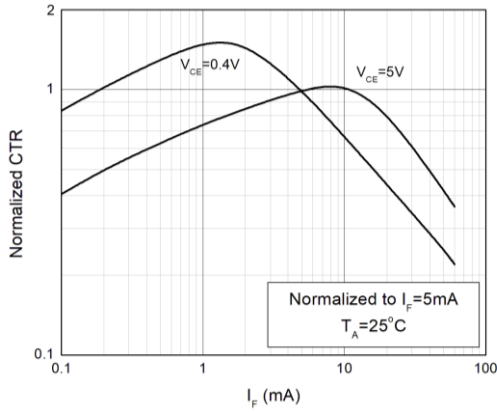


# MPC817X1 Series

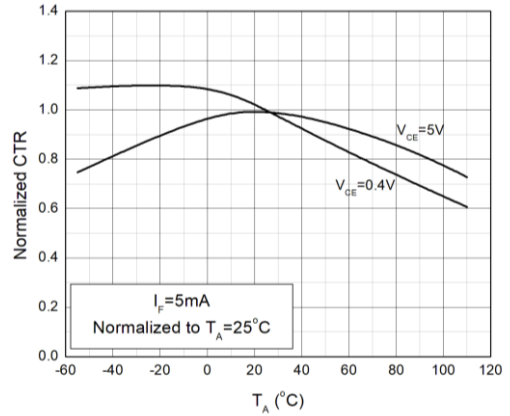
## DIP4, DC Input, Photo Transistor Coupler

### CHARACTERISTIC CURVES

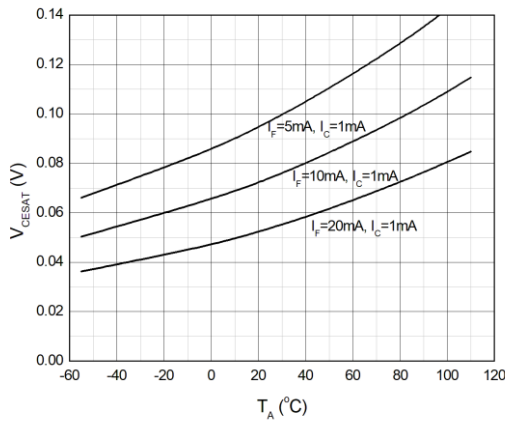
**Fig.7 Normalized Current Transfer Ratio vs. Forward Current**



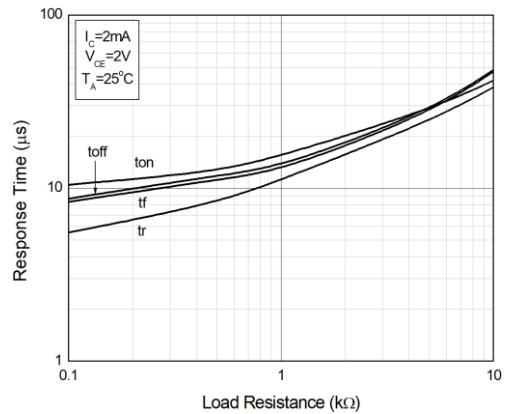
**Fig.8 Normalized Current Transfer Ratio vs. Ambient Temperature**



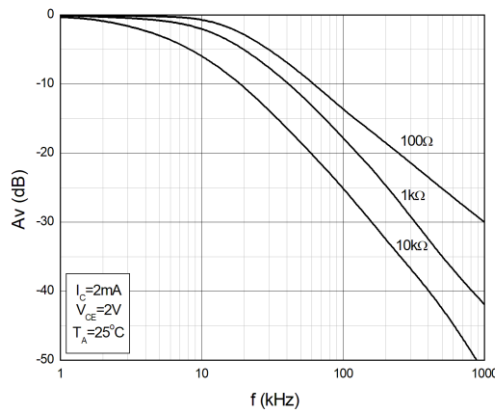
**Fig.9 Collector-emitter Saturation Voltage vs. Ambient Temperature**



**Fig.10 Switching Time vs. Load Resistance**

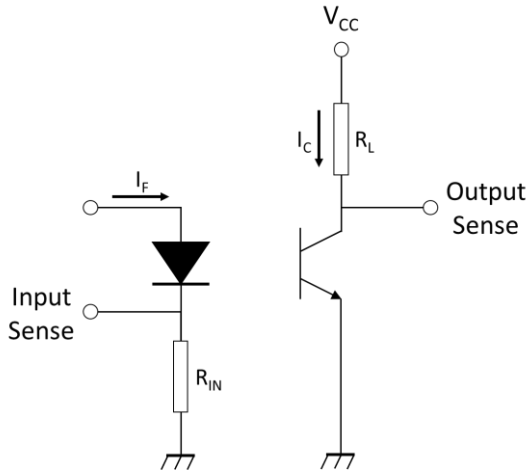


**Fig.11 Frequency Response**

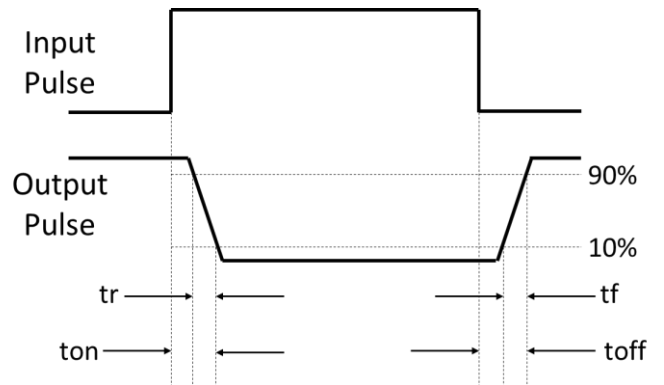


### TEST CIRCUITS

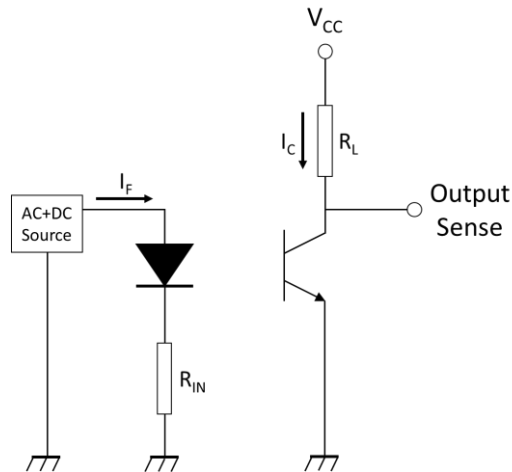
**Fig.12 Test Circuits of Response Time**



**Fig.13 Curves of Response Time**



**Fig.14 Test Circuits of Frequency Response**



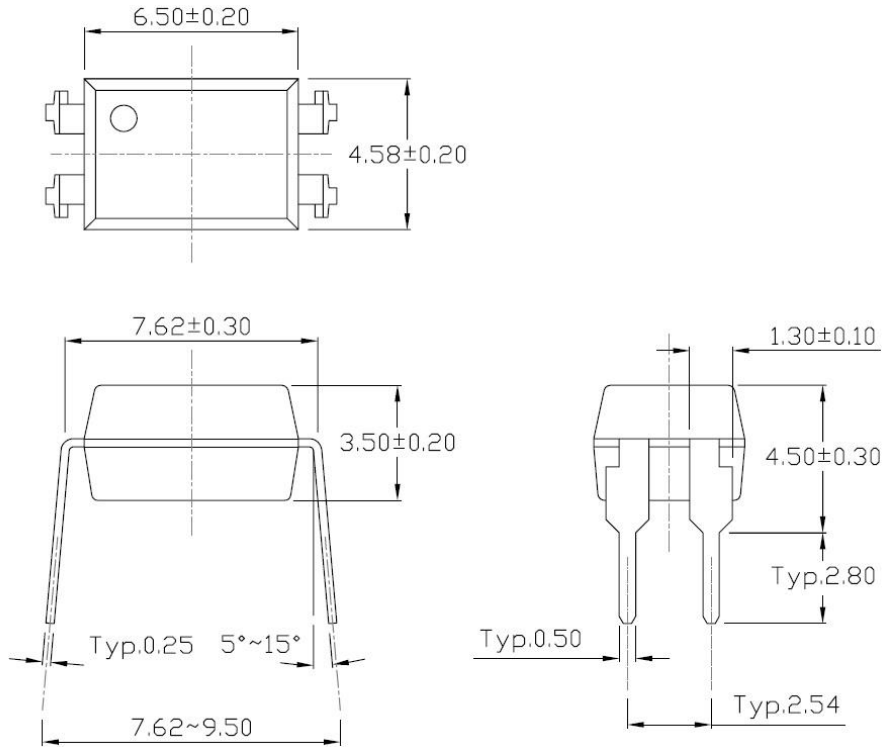


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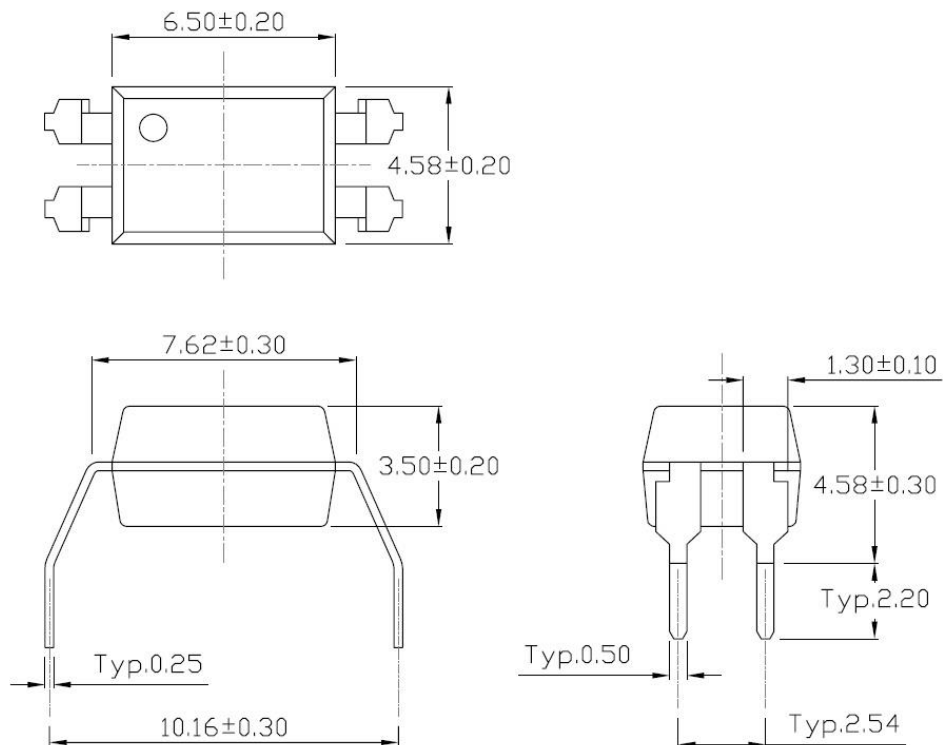
## DIP4, DC Input, Photo Transistor Coupler

### PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)

#### Standard DIP – Through Hole (DIP Type)



#### Gullwing (400mil) Lead Forming – Through Hole (M Type)



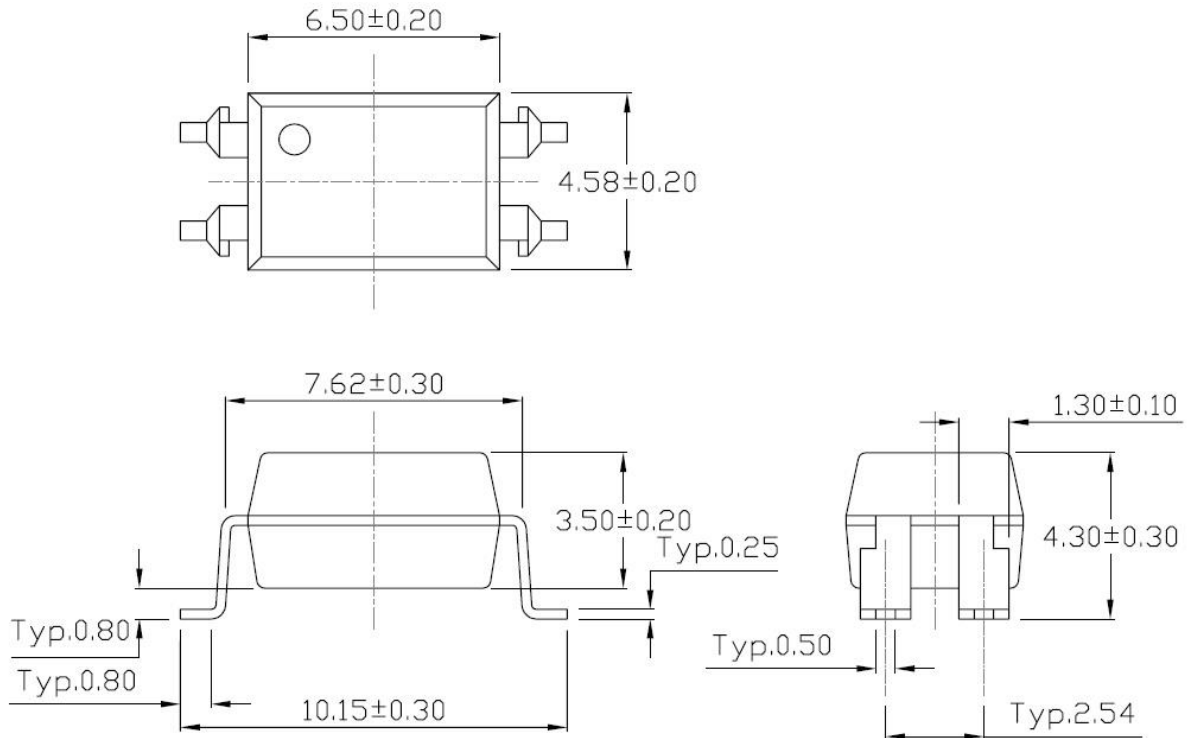


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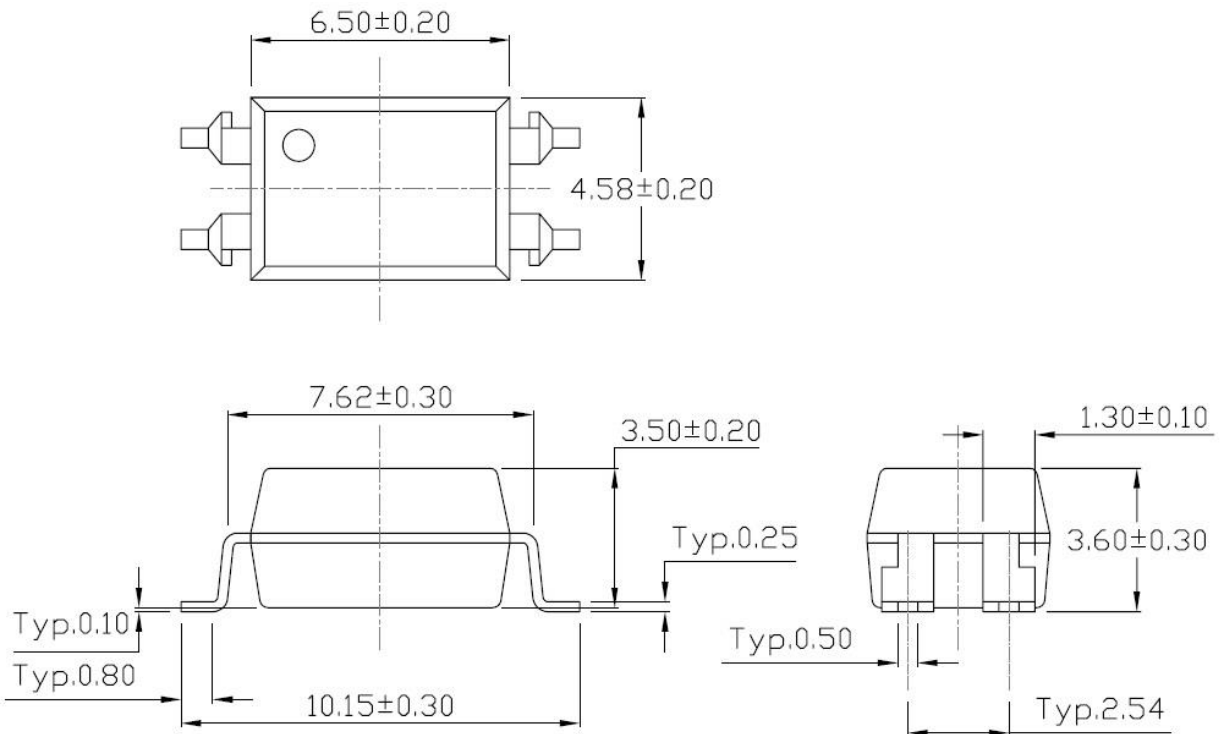
## DIP4, DC Input, Photo Transistor Coupler

### PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)

#### Surface Mount Lead Forming (S Type)



#### Surface Mount (Low Profile) Lead Forming (SL Type)





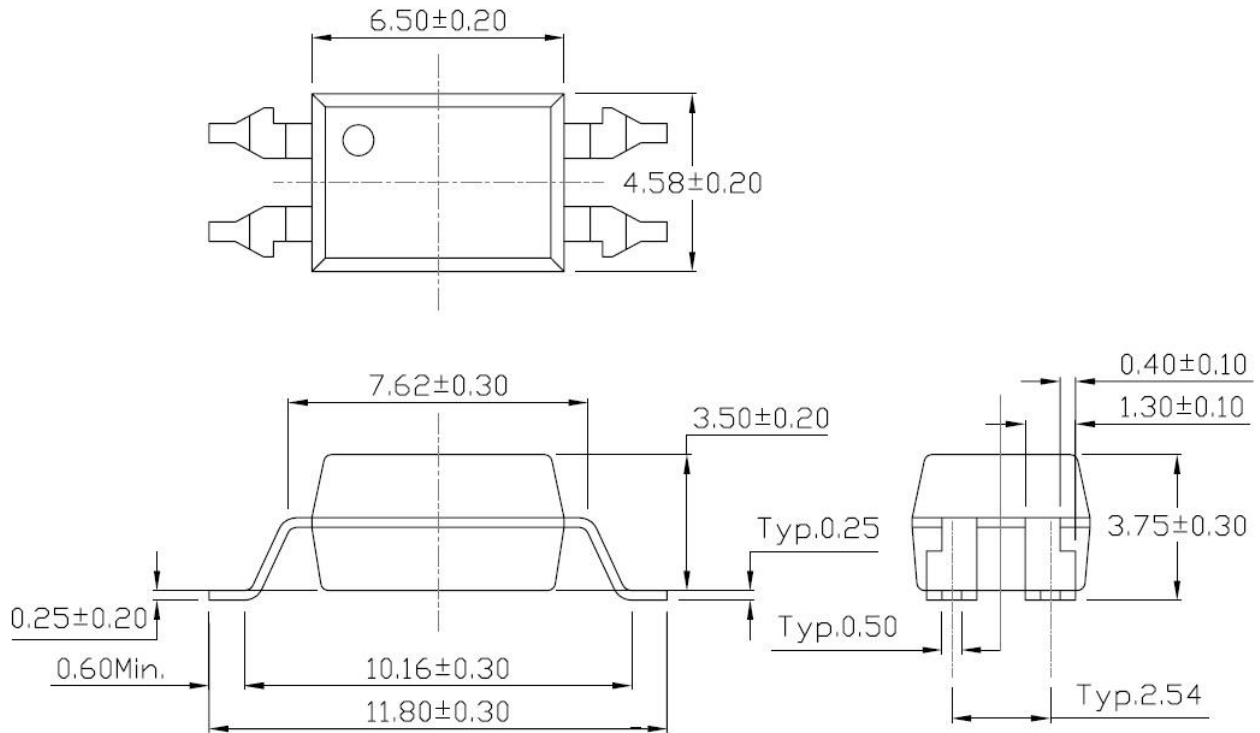


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## DIP4, DC Input, Photo Transistor Coupler

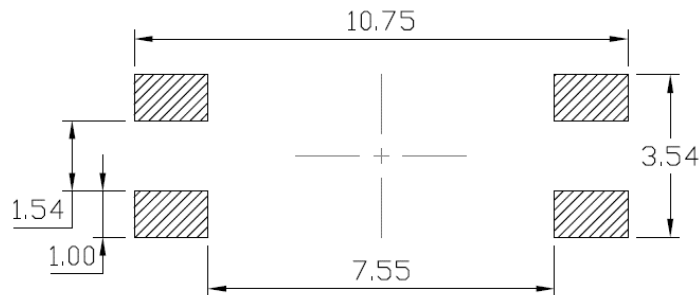
### PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)

#### Surface Mount (Gullwing) Lead Forming (SLM Type)

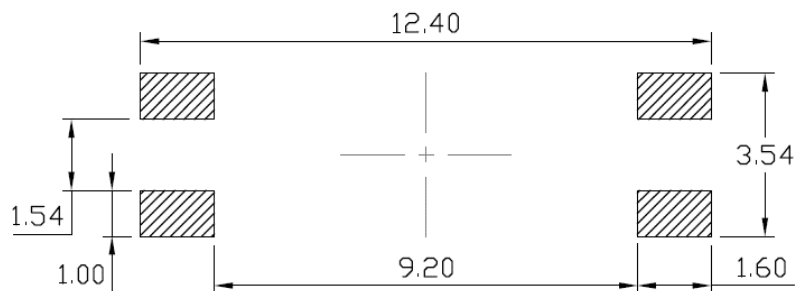


### RECOMMENDED SOLDER MASK (Dimensions in mm unless otherwise stated)

#### Surface Mount Lead Forming & Surface Mount (Low Profile) Lead Forming



#### Surface Mount (Gullwing) Lead Forming



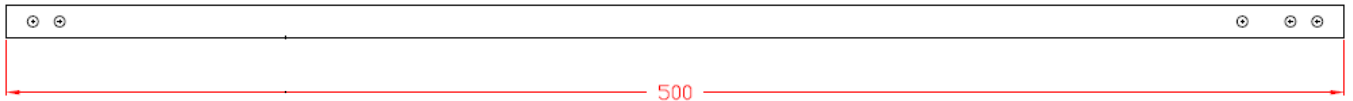
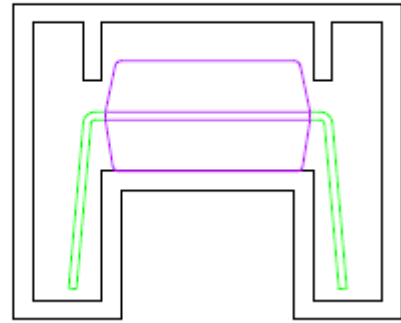
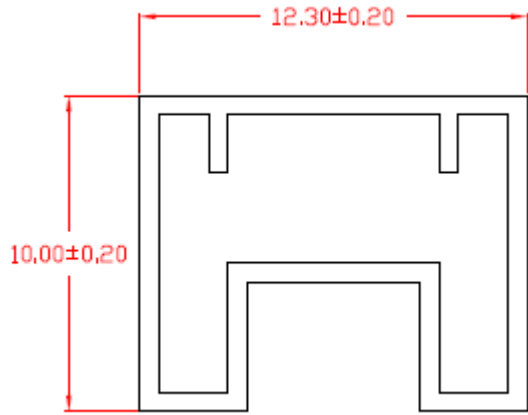


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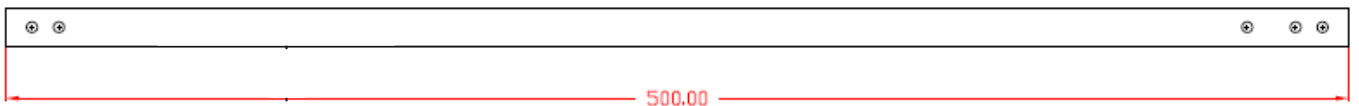
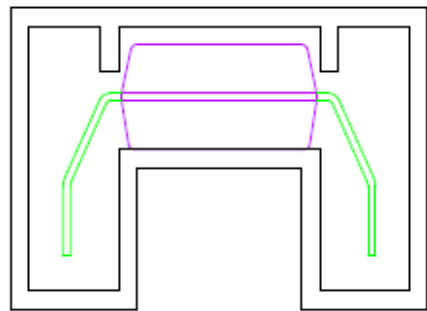
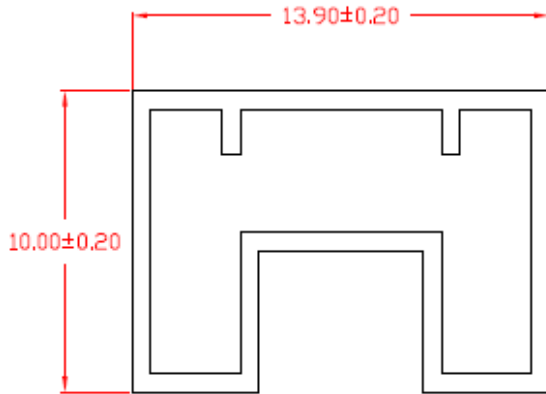
## DIP4, DC Input, Photo Transistor Coupler

### TUBE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

#### Standard DIP



#### Option M



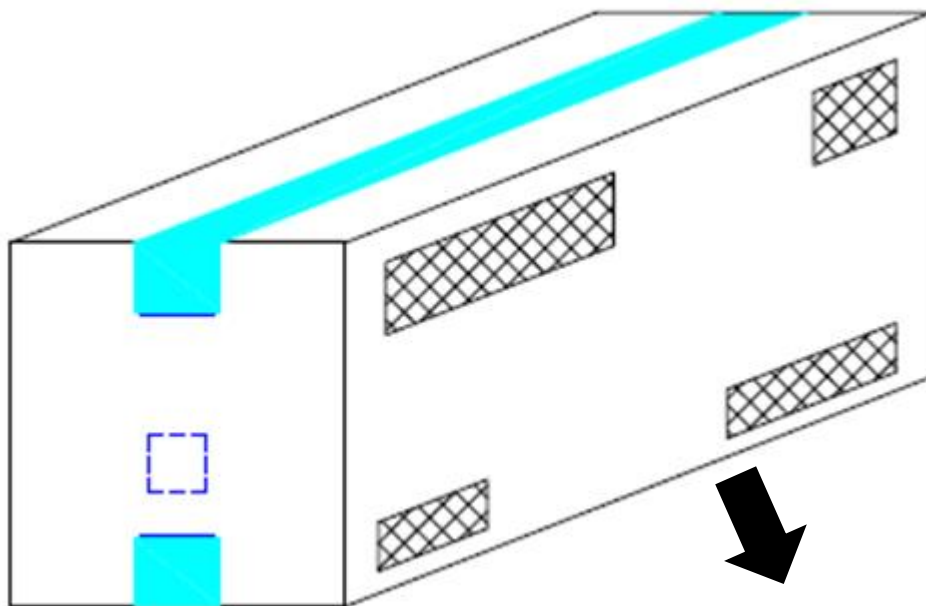
### BOX SPECIFICATIONS (Tube Type)

#### Inner Box



- L x W x H = 52.5cm x 10.7cm x 4.7cm

#### Outer Box



- L x W x H = 53.5cm x 23.5cm x 25.5cm

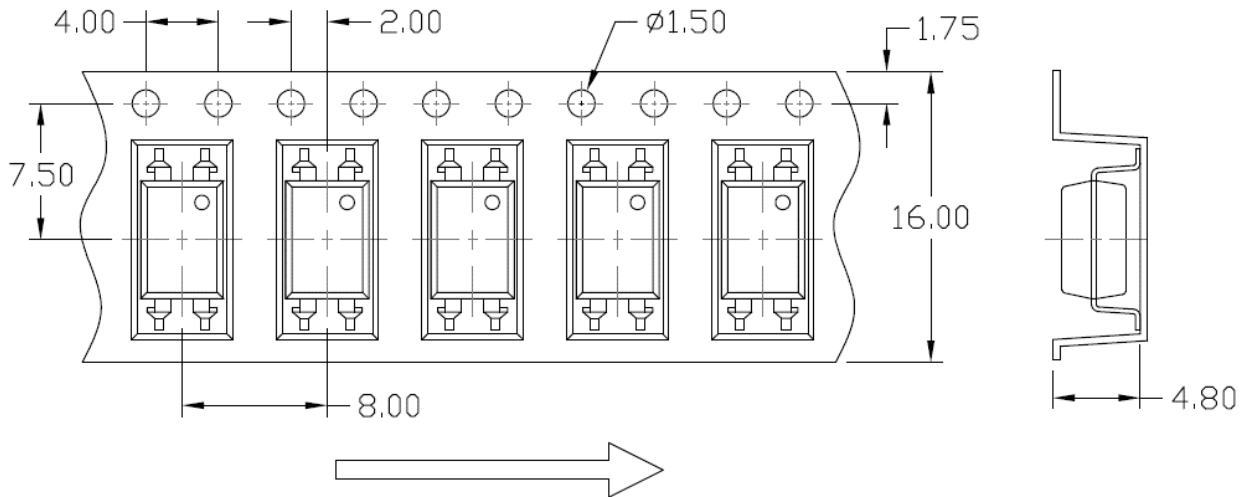


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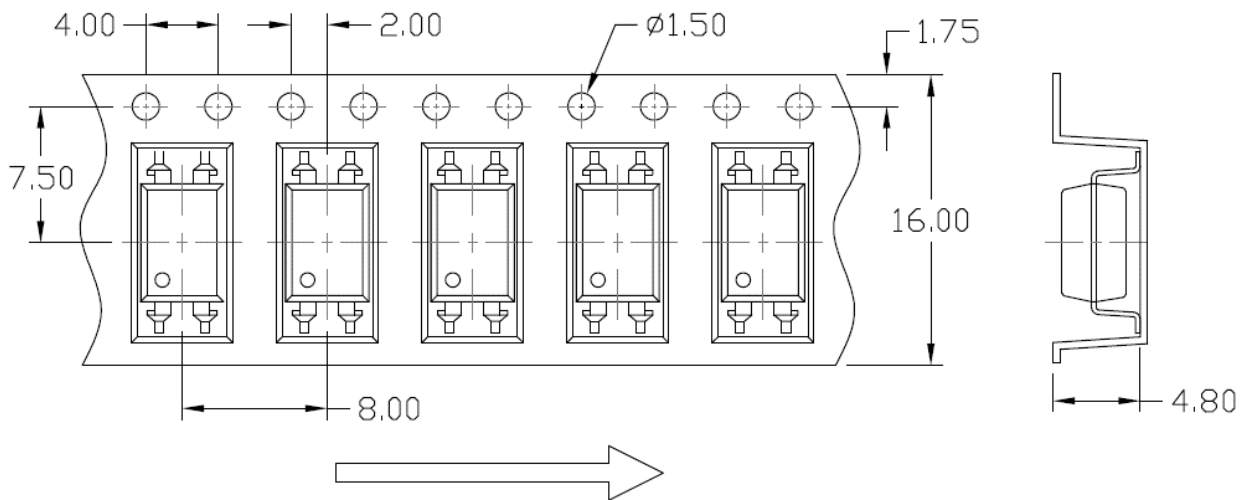
## DIP4, DC Input, Photo Transistor Coupler

### CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

#### Option S(T1) & SL(T1)



#### Option S(T2) & SL(T2)



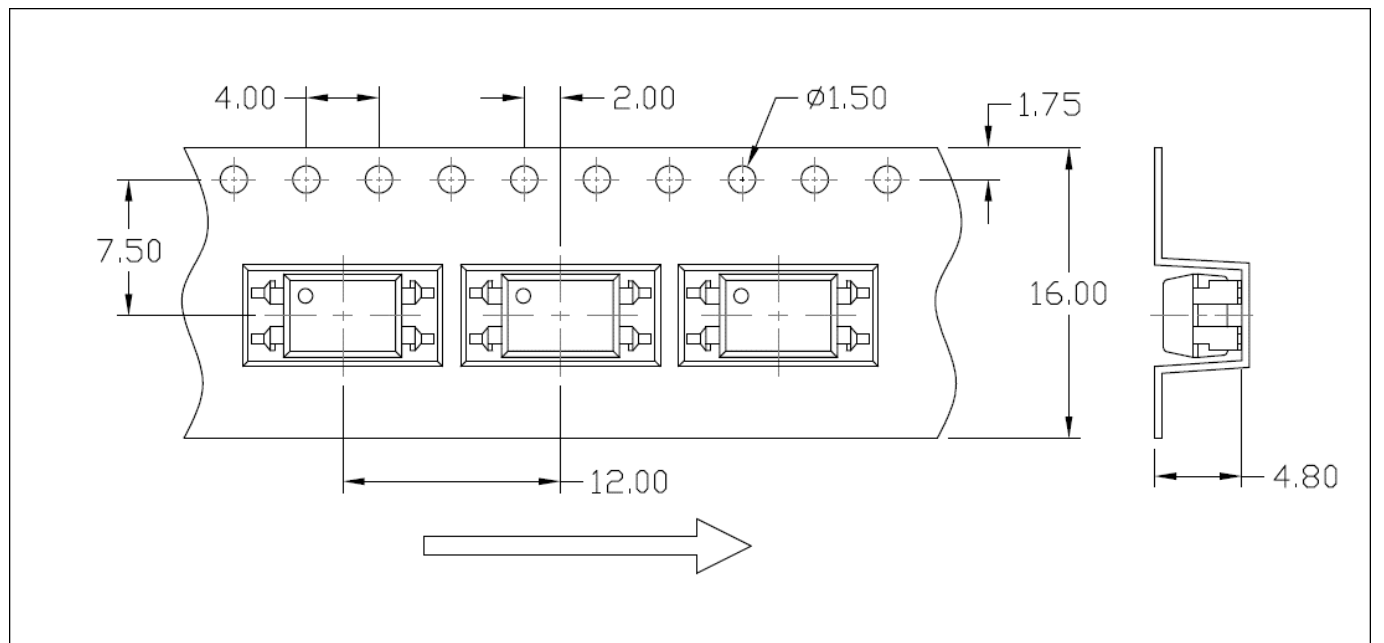


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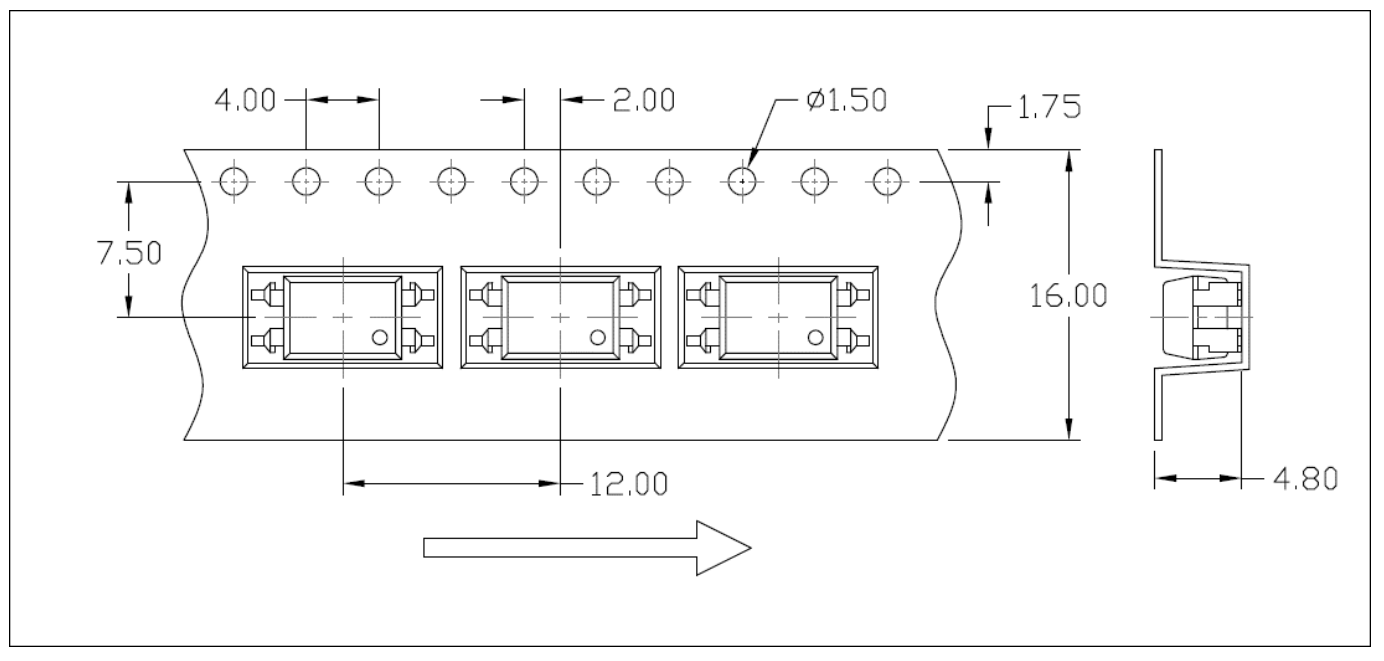
## DIP4, DC Input, Photo Transistor Coupler

### CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

#### Option S(T3) & SL(T3)



#### Option S(T4) & SL(T4)



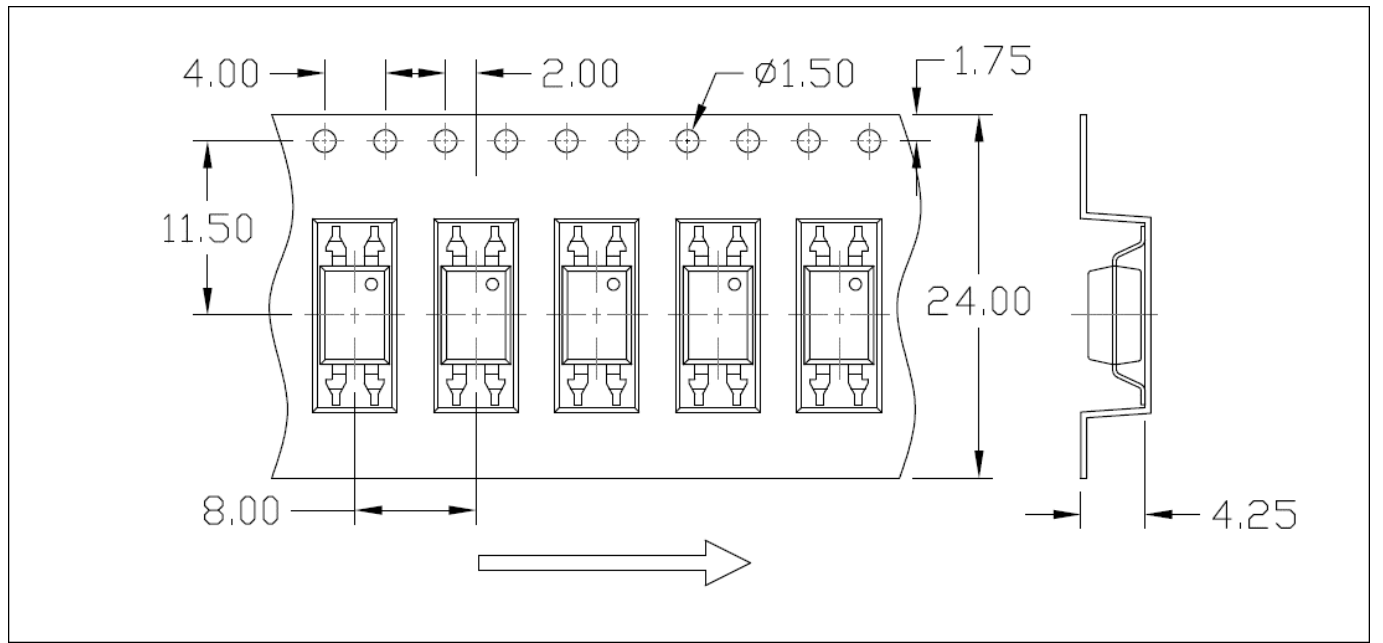


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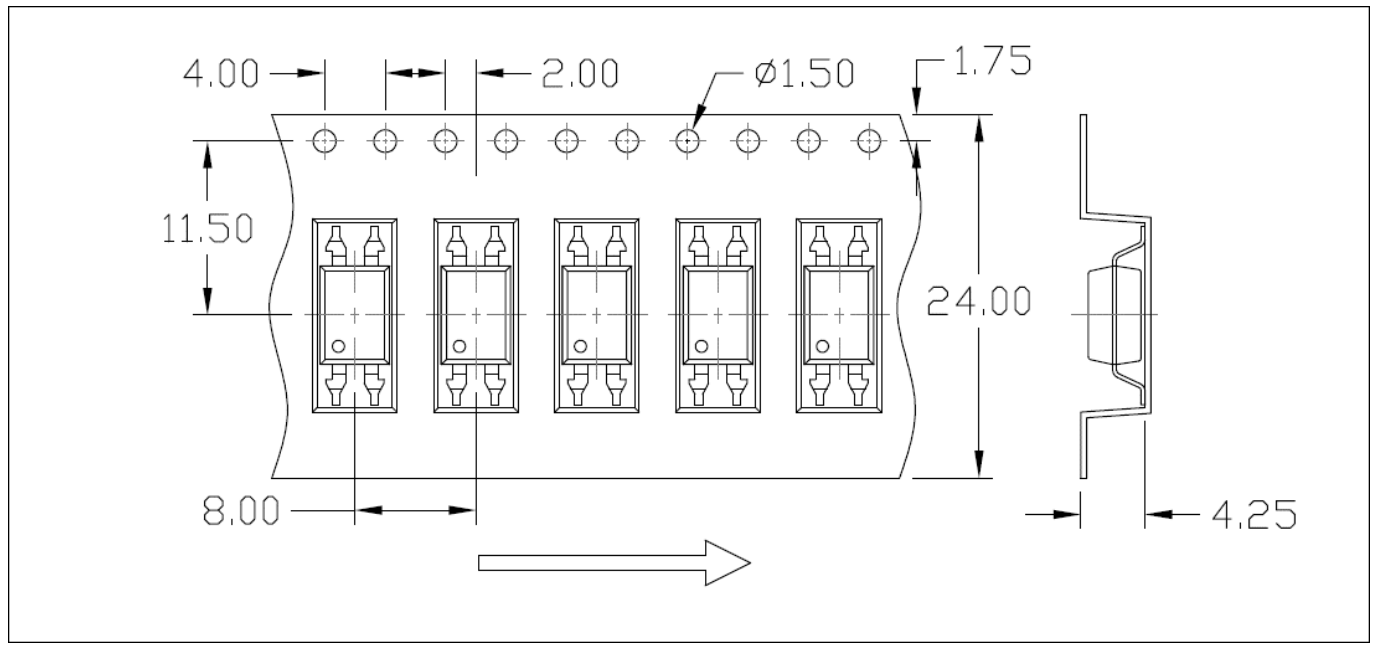
## DIP4, DC Input, Photo Transistor Coupler

### CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

#### Option SLM(T1)



#### Option SLM(T2)



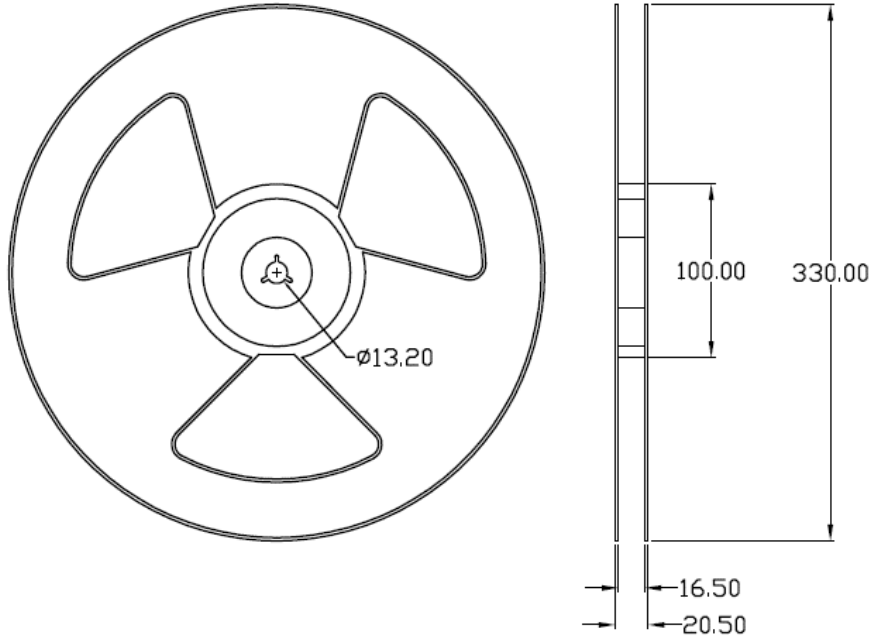


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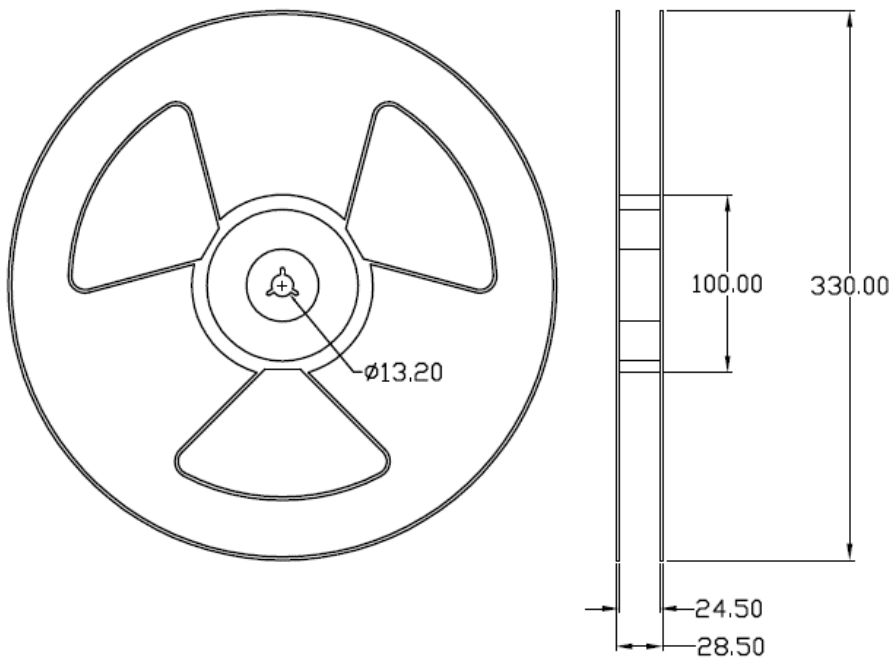
## DIP4, DC Input, Photo Transistor Coupler

### REEL SPECIFICATIONS (Dimensions in mm unless otherwise stated)

#### Option S & Option SL

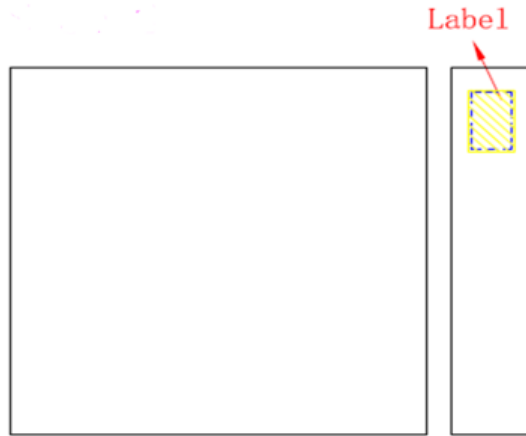


#### Option SLM



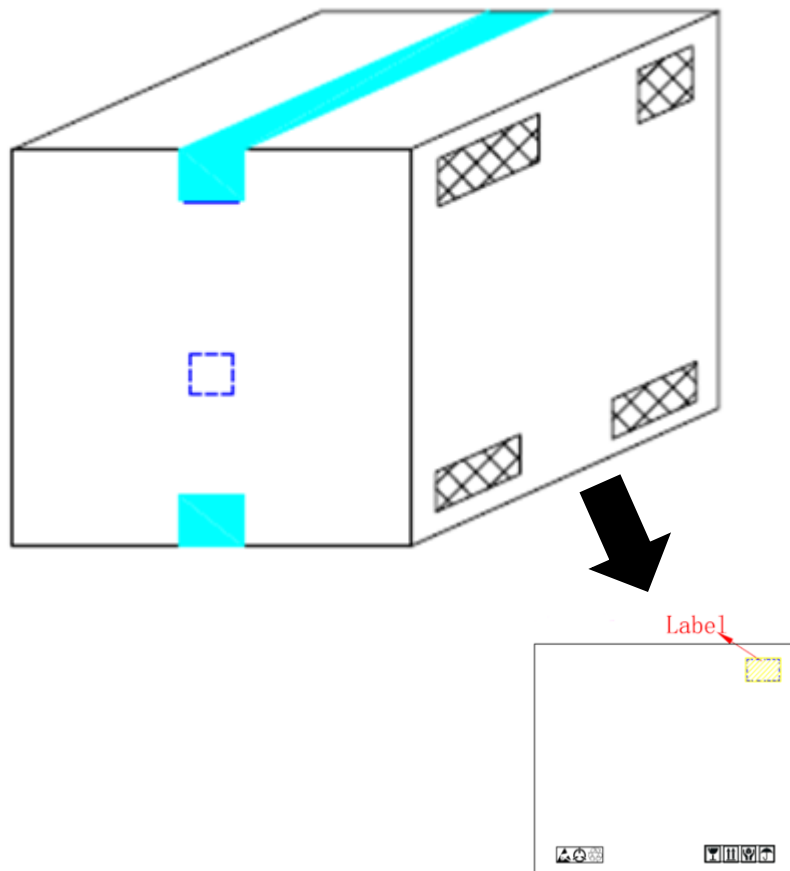
### BOX SPECIFICATIONS (Reel Type)

#### Inner Box



- L x W x H = 36cm x 36cm x 6.9cm

#### Outer Box



- L x W x H = 45cm x 38cm x 38cm





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### ORDERING AND MARKING INFORMATION

#### MARKING INFORMATION



**MPC** : Company Abbr.  
**817** : Part Number  
**X** : CTR Rank  
**F** : Leadframe Option  
**V** : VDE Option  
**Y** : Fiscal Year  
**A** : Manufacturing Code  
**WW** : Work Week

#### ORDERING INFORMATION

### MPC817X1(Y)(Z)-(F)(G)(V)

MPC – Company Abbr.  
 817 – Part Number  
 X1 – Rank (A1/B9/C1/D1)  
 Y – Lead Form Option (M/S/SL/SLM/None)  
 Z – Tape and Reel Option (T1/T2/T3/T4)  
 F – Leadframe Option (F:Iron, None:Copper)  
 G – Green Option (G or None)  
 V – VDE Option (V or None)  
 NOTE: It's not applicable to MPC-817B1(Y)(Z)-FGV.

#### LABEL INFORMATION



#### Packing Quantity

Option	Quantity	Quantity – Inner box	Quantity – Outer box
None	100 Units/Tube	32 Tubes/Inner box	10 Inner box/Outer box = 32k Units
M	100 Units/Tube	28 Tubes/Inner box	10 Inner box/Outer box = 32k Units
S(T1)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units
S(T2)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units
S(T3)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units
S(T4)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units
SL(T1)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units
SL(T2)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units
SL(T3)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units
SL(T4)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units
SLM(T1)	1500 Units/Reel	2 Reels/Inner box	5 Inner box/Outer box = 15k Units
SLM(T2)	1500 Units/Reel	2 Reels/Inner box	5 Inner box/Outer box = 15k Units

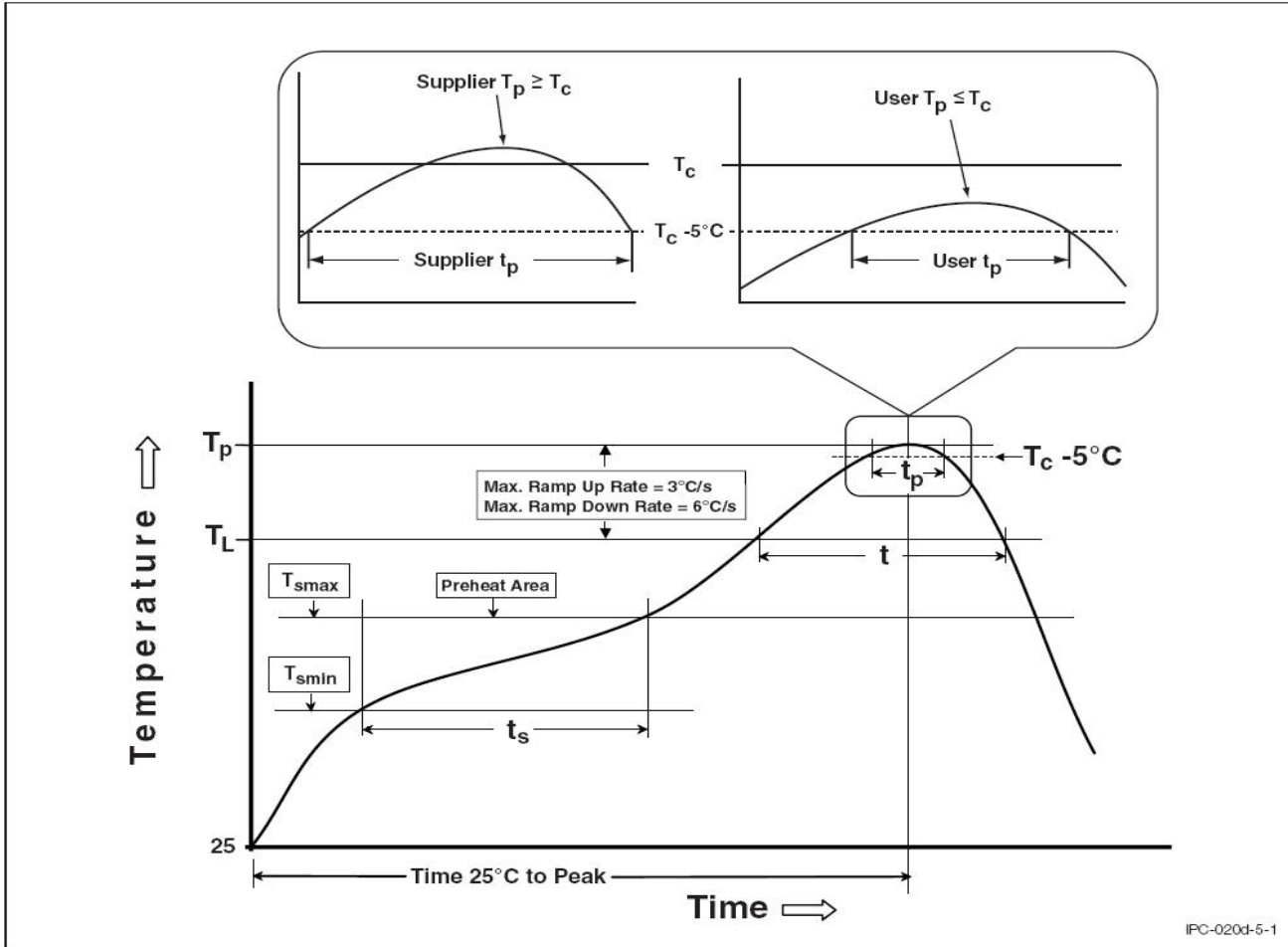
Rev: V1.4

Release Date: 2024/4/15



### REFLOW INFORMATION

#### REFLOW PROFILE



Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (T <sub>smin</sub> )	100°C	150°C
Temperature Max. (T <sub>smax</sub> )	150°C	200°C
Time (t <sub>s</sub> ) from (T <sub>smin</sub> to T <sub>smax</sub> )	60-120 seconds	60-120 seconds
Ramp-up Rate (t <sub>L</sub> to t <sub>P</sub> )	3°C/second max.	3°C/second max.
Liquidous Temperature (T <sub>L</sub> )	183°C	217°C
Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C
Time (t <sub>P</sub> ) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (T <sub>P</sub> to T <sub>L</sub> )	6°C/second max	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.



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### DISCLAIMER

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- The characteristic curves shown in this datasheet are representing typical performance which are not guaranteed.
- WISELITE makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, WISELITE disclaims (a) any and all liability arising out of the application or use of any product, (b) any and all liability, including without limitation special, consequential or incidental damages, and (c) any and all implied warranties, including warranties of fitness for particular
- The products shown in this publication are designed for the general use in electronic applications such as office automation, equipment, communications devices, audio/visual equipment, electrical application and instrumentation purpose, non-infringement and merchantability.
- This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or lifesaving applications or any other application which can result in human injury or death.
- Please contact WISELITE sales agent for special application request.
- Immerge unit's body in solder paste is not recommended.
- Parameters provided in datasheets may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated in each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify WISELITE's terms and conditions of purchase, including but not limited to the warranty expressed therein.
- Discoloration might be occurred on the package surface after soldering, reflow or long-time use. It neither impacts the performance nor reliability.

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